



APR 18 2002

UNITED STATES PATENT AND TRADEMARK OFFICE

COMMISSIONER FOR PATENTS  
UNITED STATES PATENT AND TRADEMARK OFFICE  
WASHINGTON, D.C. 20231  
www.uspto.gov

APPLICATION NUMBER	FILING/RECEIPT DATE	FIRST NAMED APPLICANT	ATTORNEY DOCKET NUMBER
10/042,829	01/08/2002	Chi Wah Cheng	P/4076-10

CONFIRMATION NO. 7316

000002352  
OSTROLENK FABER GERB & SOFFEN  
1180 AVENUE OF THE AMERICAS  
NEW YORK, NY 100368403

FORMALITIES LETTER



\*OC000000007473729\*

Date Mailed: 02/14/2002

## NOTICE TO FILE MISSING PARTS OF NONPROVISIONAL APPLICATION

FILED UNDER 37 CFR 1.53(b)

*Filing Date Granted*

An application number and filing date have been accorded to this application. The item(s) indicated below, however, are missing. Applicant is given **TWO MONTHS** from the date of this Notice within which to file all required items and pay any fees required below to avoid abandonment. Extensions of time may be obtained by filing a petition accompanied by the extension fee under the provisions of 37 CFR 1.136(a).

- The oath or declaration is unsigned.
- To avoid abandonment, a late filing fee or oath or declaration surcharge as set forth in 37 CFR 1.16(l) of \$130 for a non-small entity, must be submitted with the missing items identified in this letter.
- **The balance due by applicant is \$ 130.**

The application is informal since it does not comply with the regulations for the reason(s) indicated below.

The required item(s) identified below must be timely submitted to avoid abandonment:

- Substitute drawings in compliance with 37 CFR 1.84 because:
  - drawings have a line quality that is too light to be reproduced (weight of all lines and letters must be heavy enough to permit adequate reproduction) or text that is illegible (reference characters, sheet numbers, and view numbers must be plain and legible)

see 37 CFR 1.84(l) and (p)(1));

04/19/2002 SSESHE1 00000082 10042829

01 FC:105

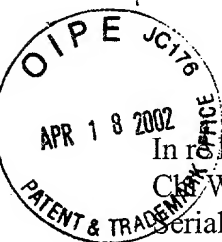
130.00 DP

*A copy of this notice **MUST** be returned with the reply.*

Customer Service Center  
Initial Patent Examination Division (703) 308-1202

PART 2 - COPY TO BE RETURNED WITH RESPONSE

2023-04-04 10:42:30



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

Chih Wah CHENG, et al.

Serial No.: 10/042,829

Filed: January 8, 2002

Date: April 12, 2002

Group Art Unit: ---

Examiner: ---

For: APPARATUS AND METHOD OF PLACING SOLDER BALLS ONTO A SUBSTRATE

Asst. Commissioner for Patents

Washington, DC 20231

Attention: Application Branch

RESPONSE TO NOTICE TO FILE MISSING  
PARTS OF APPLICATION - FILING DATE GRANTED

Sir:

In response to the Notice to File Missing Parts of Application - Filing Date Granted, mailed February 14, 2002, submitted herewith is the Inventor(s) Declaration and our Check No. 08839 which includes the amount of \$130.00 (Large Entity) in payment of the surcharge.

In the event the actual fee is greater than the payment submitted or is inadvertently not enclosed or if any additional fee during the prosecution of this application is not paid, the Patent Office is authorized to charge the underpayment to Deposit Account #15-0700.

If this communication is filed after the time period had elapsed and no separate Petition is enclosed, the Commissioner of Patents and Trademarks is petitioned, under 37 C.F.R. §1.136(a), to extend the time for filing a response by the number of months which will avoid abandonment under 37 C.F.R. §1.135. The fee under 37 C.F.R. § 1.17 should be charged to our Deposit Account No. 15-0700.

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Asst. Comm. for Patents, Washington, D.C. 20231, on April 12, 2002:

Robert C. Faber

Name of applicant, assignee or  
Registered Representative

Signature

April 12, 2002

Date of Signature

Respectfully submitted,

Robert C. Faber

Registration No.: 24,322

OSTROLENK, FABER, GERB & SOFFEN, LLP

1180 Avenue of the Americas

New York, New York 10036-8403

Telephone: (212) 382-0700

RCF:sds

Enclosures



OFGS File No.: P/4076-10

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

Chi Wah CHENG, et al.

Date: April 12, 2002

Serial No.: 10/042,829

Group Art Unit: ---

Filed: January 8, 2002

Examiner: ---

For: APPARATUS AND METHOD OF PLACING SOLDER BALLS ONTO A SUBSTRATE

---

Asst. Commissioner for Patents  
Washington, D.C. 20231

SUBMISSION

Sir:

Submitted herewith is a copy of prior art together with a form listing the same for the convenience of the Examiner.

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231, on April 12, 2002

Respectfully submitted,

Robert C. Faber Esq.

\_\_\_\_\_  
Name of applicant, assignee or  
Registered Representative

\_\_\_\_\_  
Signature

\_\_\_\_\_  
April 12, 2002

\_\_\_\_\_  
Date of Signature

Robert C. Faber

Registration No.: 24,322

OSTROLENK, FABER, GERB & SOFFEN, LLP

1180 Avenue of the Americas

New York, New York 10036-8403

Telephone: (212) 382-0700

RCF:sds  
Enclosures